

03-31-2004

Docket No.: 2004P50589US/1331.140.101



3.24.04

TC
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102712940

22857 U.S. PTO
10/808190
0324041. Name of conveying party(ies):
Jung Pill Kim

2. Name and address of receiving party(ies):

Name: Infineon Technologies North America Corp.

Internal Address:

Street Address: 1730 North First Street

City: San Jose State: CA ZIP: 95112

Country:

Additional name(s) of conveying party(ies) attached?

☒ No ☐ Yes

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Additional name(s) & addresses attached?

☐ Yes ☒ No

Execution Date: March 18, 2004

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: March 18, 2004

A. Patent Application Serial No.(s)/Filing Date(s)

10808190

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No5. Name and address of party to whom correspondence
concerning document should be mailed:Name: Paul P. Kempf

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41). . \$40.00☐ Enclosed.☒ The Patent Office is hereby authorized to charge Deposit Acct. No. 50-0471 in the
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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Paul P. Kempf

(Name of Person Signing)

Signature

Date

3/24/04

Total number of pages comprising cover sheet, attachments and document: 2

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PATENT
REEL: 015145 FRAME: 0946

ASSIGNMENT

For good and valuable consideration, I, Jung Pill Kim, a citizen of Korea, residing at 139 Swan Quarter Dr., Cary, NC 27519, and _____, a citizen of _____, residing at _____, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies North America Corp.**, a corporation organized and existing under the state laws of Delaware, having its principal place of business at 1730 North First Street, San Jose, CA, 95112, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and filed herewith, entitled:

TEMPERATURE SENSOR SCHEME

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: J. P. Kim DATE: 03/18/04
NAME: (Jung Pill Kim)

SIGNATURE: _____ DATE: _____
NAME: (2nd INVENTOR)